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TFT | CHARACTER | UWVD | FSC | SEGMENT | CUSTOM | REPLACEMENT

TFT Display Module

Part Number E35RG63224LW2M350-N

Overview:

- 3.5-inch TFT: 320x240 (76.84x63.84) Transmissive/ Normally White
- 16/18/24-bit RGB Interface
- Wide Temp
- Internal Power Supply Circuit
- White LED back-light

- No Touch Panel
- 350 NITS
- Controller: HX8238D
- **RoHS** Compliant •



Description

This is a color active matrix TFT (Thin Film Transistor) LCD (Liquid Crystal Display) that uses amorphous silicon TFT as a switching device. This model is composed of a Transmissive type TFT-LCD Panel, driver circuit, back-light unit. The resolution of a 3.5" TFT-LCD contains x 40 pixels and can display up to 16.7M colors.

Features

Low Input Voltage: 3.3V (TYP) Display Colors of TFT LCD: 16.7M colors k8" Interface: k8" @ h o #

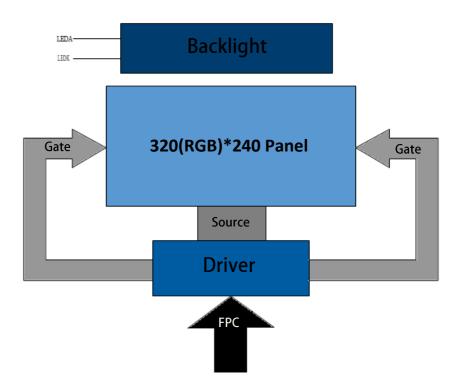
	Specification		Note
General Information Items	Main Panel	- Unit	NOLE
Display area (AA)	. (H) * (V) (3.5 inch)	mm	-
Driver element	TFT active matrix	-	-
Display colors	16.7M	colors	-
Number of pixels	480(RGB)*640	dots	-
TFT Pixel arrangement	RGB vertical stripe	-	-
Pixel pitch	0. (H) x 0.1 (V)	mm	-
Viewing angle		o'clock	-
TFT Controller IC	HX)	-	-
Display mode	Transmissive/Normally ‡	-	-
Operating temperature	-20~+70	°C	_
Storage temperature	-30~+80	°C	-

Mechanical Information

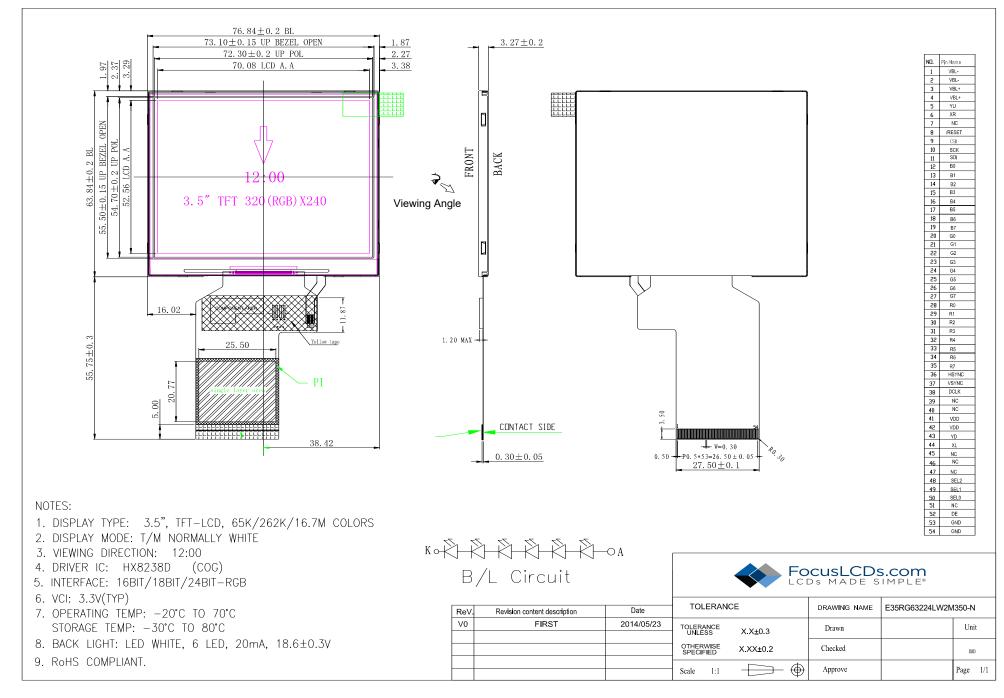
ltem		Min	Тур.	Max	Unit	Note
	Horizontal(H)				mm	-
Module size	Vertical(V)				mm	-
Depth(D)			3.		mm	-
Weight			TBD		g	-



1. Block Diagram



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3. Input Terminal Pin Assignment

Recommended Connector: F32R-1A7H1-11054

NO.	Symbol	Description	I/O
1	BLK	Cathode pin of backlight	Р
2	BLK	Cathode pin of backlight	Р
3	BLA	Anode pin of backlight	Р
4	BLA	Anode pin of backlight	Р
5	YU(NC)	Touch panel top film terminal	A/D
6	XR(NC)	Touch panel right glass terminal	A/D
7	NC		
8	RESET	System reset pin. Internal pull high. Connect to VDDIO when not used.	I
9	CSB	Chip select of serial interface. Internal pull high. Leave open when not used.	I
10	SCK	Clock pin of serial interface. Internal pull high. Leave open when not used.	Ι
11	SDI	Data input pin of serial interface. Internal pull high. Leave open when not used.	Ι
12-19	B0-B7	Blue data input.	Ι
20-27	G0-G7	Green data input.	I
28-35	RO-R7	Red data input.	I
36	HSYNC	Horizontal sync input. Negative polarity.	Ι
37	VSYNC	Vertical sync input. Negative polarity.	Ι
38	DCLK	Clock signal. Latching data at the rising edge.	Ι
39	NC		
40	NC		
41	VDD	Supply voltage (3.3V)	Р
42	VDD	Supply voltage (3.3V)	Р
43	YD(NC)	Touch panel bottom film terminal	A/D
44	XL(NC)	Touch panel left glass terminal	A/D
45-47	NC		
48	SEL2	Input pin to select input interface mode.	Ι
49	SEL1	Input pin to select input interface mode.	Ι
50	SELO	Input pin to select input interface mode.	I
51	NC		
52	DE	Data input enable. Active high to enable the data input bus under "DE	1
		mode". Leave open when not used.	
53	GND	Ground	Р
54	GND	Ground	Р



4. LCD Optical Characteristics

4.1 Optical specification

ltem		Symbol	Condition	Min	Тур.	Max	Unit	Note
Contrast R	atio	CR	0.0	200	300			(2)
Transmitta	ance	Т%	Θ=0 Normal		7.4		%	(3)
Response time	Rising	Tr	viewing angle		15	30	ms	(4)
Response time	Falling	Tf	viewing ungle		35	50	ms	(4)
		Wx		0.282	0.312	0.342		
	White	W _Y		0.319	0.349	0.379		
		R _x		0.609	0.639	0.669		
Color Filter	Red	R _Y		0.314	0.344	0.374		(5)(6)
Color Filter Chromaticity		Gx		0.264	0.294	0.324		
,	Green	Gy		0.557	0.587	0.617		
		B _x		0.102	0.132	0.162		
	Blue	B _Y		0.106	0.136	0.166		
		ΘL			45			
	Hor.	ΘR			45			
Viewing angle		ΘU	CR>10		15		deg	(1)(6)
	Ver.	ΘD			35			
Option View D	Option View Direction 12:00						1	

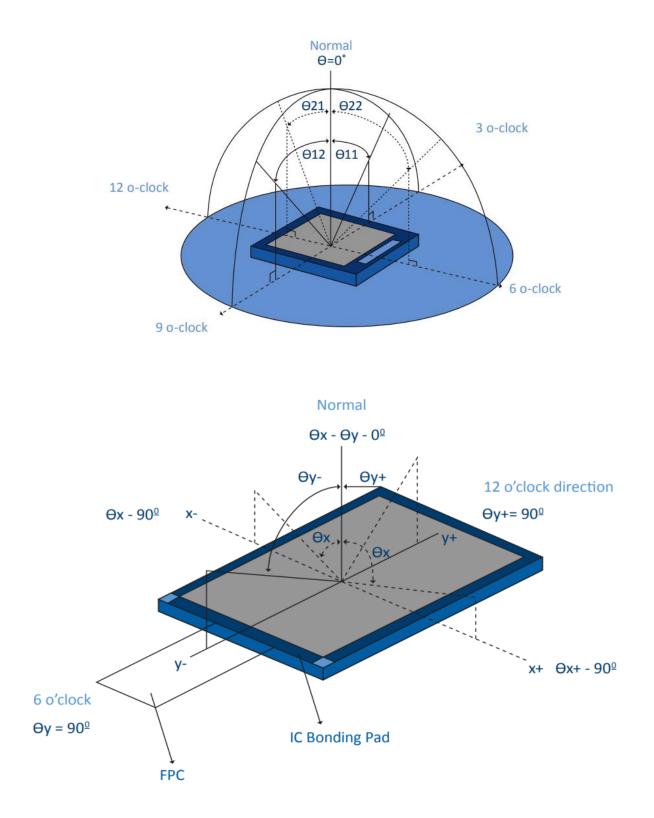
4.2 Measuring conditions

Measuring surrounding: dark room Ambient temperature: 25±2 °C 15min. warm-up time.



Optical Specification Reference Notes:

(1) Definition of Viewing Angle: The viewing angle is the angle at which the contrast ratio is greater than 10. The viewing angles are determined for the horizontal or 3,9 o'clock direction and the vertical or 6,12 o'clock direction with respect to the optical axis which is normal to the LCD surface.

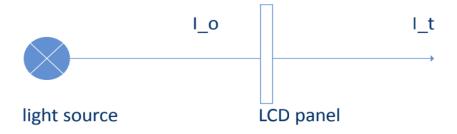




(2) Definition of Contrast Ratio (Cr): measured at the center point of panel. The contrast ratio (Cr) measured on a module, is the ratio between the luminance (Lw) in a full white area (R=G=B=1) and the luminance (Ld) in a dark area (R=G=B=0).

$$Cr = \frac{Lw}{Ld}$$

(3) Definition of transmittance (T%): The transmittance of the panel including the polarizers is measured with electrical driving.



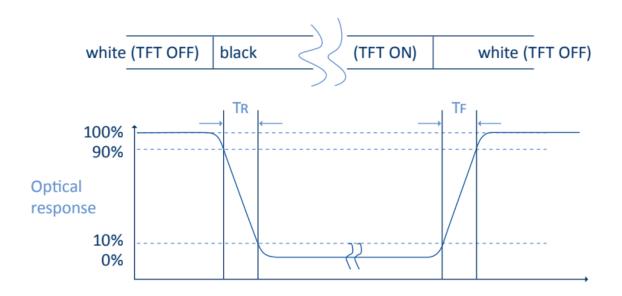
The transmittance is defined as:

$$Tr = \frac{It}{Io} x \ 100\%$$

Io = the brightness of the light source.

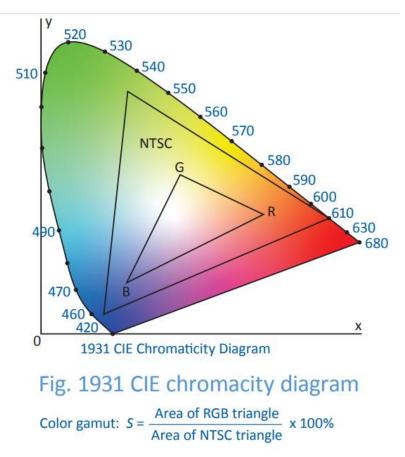
It = the brightness after panel transmission

(4) Definition of Response Time (Tr, Tf): The rise time 'Tr' is defined as the time for luminance to change from 90% to 10% as a result of a change of the electrical condition. The fall time 'Tf' is defined as the time for luminance to change from 10% to 90% as a result of a change of the electrical condition.

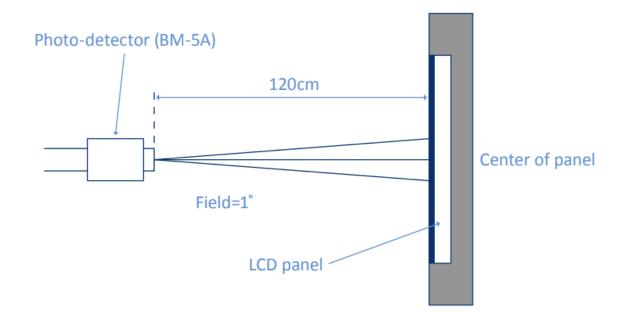




(5) Definition of Color Gamut: Measuring machine CFT-01. NTSC's Primaries: R(x,y,Y),G(x,y,Y), B(x,y,Y). FPM520 of Westar Display Technologies, INC., which utilized SR-3 for Chromaticity and BM-5A for other optical characteristics.



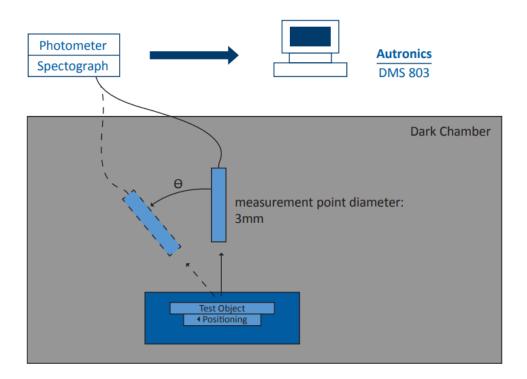
(6) Definition of Optical Measurement Setup:



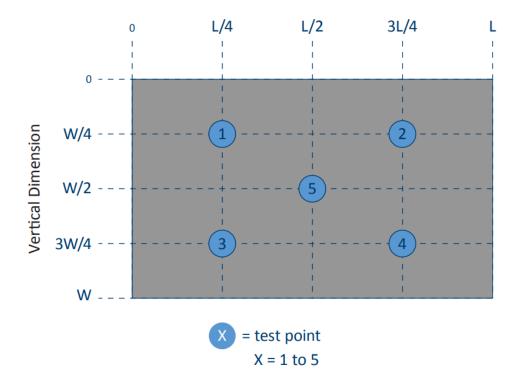


(6) Optical Measurement Setup Continued:

The LCD module should be stabilized at a given temperature for 20 minutes to avoid abrupt temperature change during measuring. In order to stabilize the luminance, the measurement should be executed after lighting backlight for 20 minutes.



Horizontal Dimension





5. Electrical Characteristics

5.1 Absolute Maximum Rating (Ta=25 VSS=0V)

Characteristics	Symbol	Min	Max	Unit
Digital Supply Voltage	VDD	3.0	5.0	V
Interface Supply Voltage	VDDIO	-0.3	4.0	V
Operating temperature	ТОР	-20	+70	°C
Storage temperature	TST	-30	+80	°C

NOTE: If the absolute maximum rating of even is one of the above parameters is exceeded even momentarily, the quality of the product may be degraded. Absolute maximum ratings, therefore, specify the values exceeding which the product may be physically damaged. Be sure to use the product within the range of the absolute maximum ratings.

5.2 DC Electrical Characteristics

Characteristics	Symbol	Min	Тур.	Max	Unit	Note
Digital Supply Voltage	VCI/VDD	3.0	3.3	3.6	V	
Interface Operation Voltage	VDDIO	1.6	3.3	3.6	V	
Normal Mode Current Consumption	IDD		10		mA	
Level input voltage	VIH	0.7 VDDIO		VDDIO	V	
	VIL	GND		0.3 VDDIO	V	
Level output voltage	VOH	VDDIO-0.4			V	
Level output voltage	VOL	GND		GND+0.4	V	



5.3 LED Backlight Characteristics

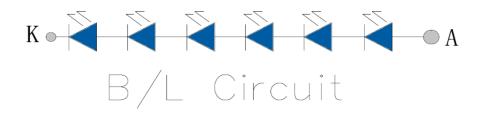
ltem	Symbol	Min	Тур.	Max	Unit	Note
Forward Current	IF	15	20		mA	
Forward Voltage	VF		19.2		V	
LCM Luminance	LV	350			cd/m2	Note 3
LED lifetime	Hr	50000			hour	Note1 & 2
Uniformity	AVg	80			%	Note 3

The back-light system is edge-lighting type with 6 chips White LED

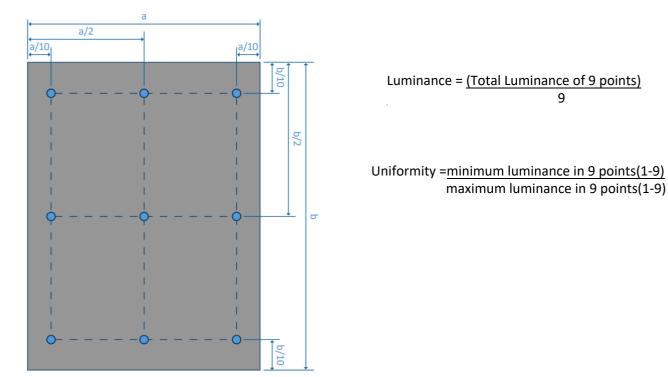
Note 1: LED lifetime (Hr) can be defined as the time in which it continues to operate under the condition:

Ta=25±3 °C, typical IL value indicated in the above table until the brightness becomes less than 50%.

Note 2: The "LED lifetime" is defined as the module brightness decrease to 50% original brightness at Ta=25°C and IL=20mA. The LED lifetime could be decreased if operating IL is larger than 20mA. The constant current driving method is suggested.

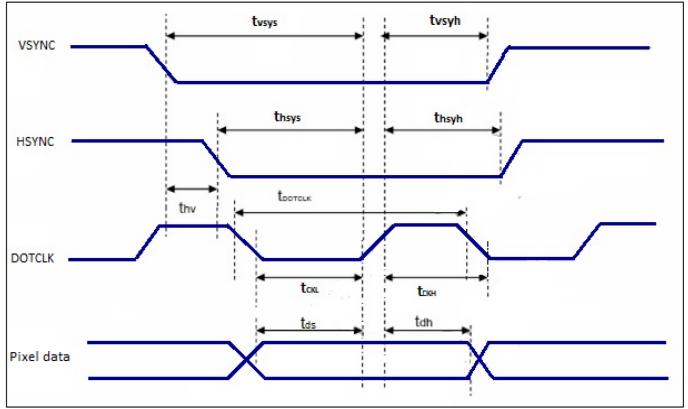


Note 3: Luminance Uniformity of these 9 points is defined as below:





6. AC Characteristic



6.1 Display Parallel RGB Interface Timing Characteristics

Figure 6.1: Parallel RGB Interface Timing Diagram

AC Electrical Characteristics (VDDIO=VDD=20 to 3.6V, GND=0V, TA=-20 to 85 ${\rm °C})$

Characteristics	Symphol	Mi	n	Ту	р.	Ma	ax	l lait
Characteristics	Symbol	24bit	8bit	24bit	8bit	24bit	8bit	Unit
DOTCLK frequency	fDOTCLK	-	-	6.5	19.5	10	30	MHz
DOTCLK period	tDOTCLK	100	33.3	154	51.3	-	-	ns
Vertical sync setup time	tvsys	20	10	-	-	-	-	ns
Vertical sync hold time	tvsyh	20	10	-	-	-	-	ns
Horizontal sync setup time	thsys	20	10	-	-	-	-	ns
Horizontal sync hold time	thsyh	20	10	-	-	-	-	ns
Phase difference of sync signal falling edge	thv	1	1	-	-	240	240	tDOTCLK
DOTCLK low period	tCKL	50	15	-	-	-	-	ns
DOTCLK high period	tCKH	50	15	-	-	-	-	ns
Data setup time	tds	12	10	-	-	-	-	ns
Data hold time	tdh	12	10	-	-	-	-	ns
Reset pulse width	tRES	10	10	-	-	-		ns

Table 6.1: Parallel RGB Interface Timing Characteristics

Note: External clock source must be provided to DOTCLK pin of HX8238-D. The driver will not operate if absent of the clocking signal.



6.2 Clock and Data Input Waveforms

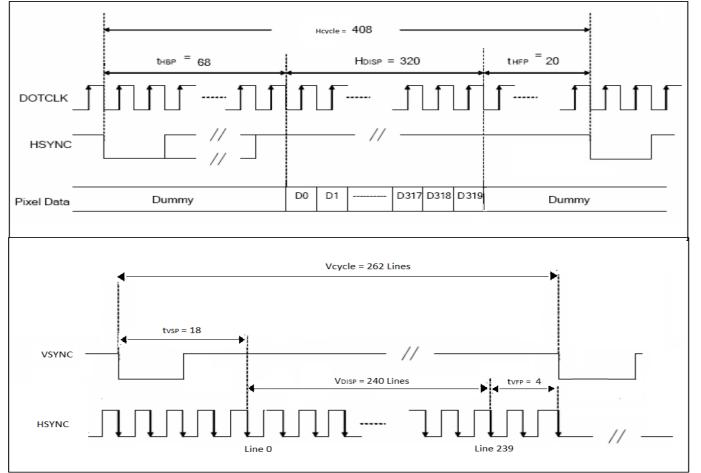


Figure 6.2: Vertical and Horizontal Data Transaction Timing Diagram

Character	Characteristics		M	lin	Тур.		Max		
Character			24bit	8bit	24bit	8bit	24bit	8bit	Unit
DOTCLK Frequen	су	fDOTCLK	-	-	6.5	19.5	10	30	MHz
DOTCLK Period		tDOTCLK	100	33.3	154	51.3	-	-	ns
Horizontal Freque	ency (Line)	fH	-	-	14	.9	22.	35	kHz
Vertical Frequence	cy (Refresh)	fV	-	-	60	C	90	0	Hz
Horizontal Back F	orch	tHBP	-	-	68	204	-	-	tDOTCLK
Horizontal Front	Porch	tHFP	-	-	20	60	-	-	tDOTCLK
Horizontal Data S	tart Point	tHBP	-	-	68	204	-	-	tDOTCLK
Horizontal Blanki	Horizontal Blanking Period		-	-	88	264	-	-	tDOTCLK
Horizontal Displa	Horizontal Display Area		-	-	320	960	-	-	tDOTCLK
Horizontal Cycle		Hcycle	-	-	408	1224	450	1350	tDOTCLK
Vertical Back Por	ch	tVBP	-	-	18		-	-	Lines
Vertical Front Po	rch	tVFP	-	-	4		-	-	Lines
Vertical Data Star	rt Point	tVBP	-	-	18	8	-	-	Lines
Vertical Blacking	Period	tVBP+tVFP	-	-	22	2	-	-	Lines
Mantinal Dianlass	NTSC				24	.0			
Vertical Display PAL		VDISP	-	-	280(PA	LM=0)	-	-	Lines
Area PAL					288(PA	LM=1)			
Vartical Cucla	NTSC				262		250		
Vertical Cycle	PAL	Vcycle	-	-	313		- 350		Lines

Table 6.2: Vertical and Horizontal Timing Characteristics



6.3 Reset Timing

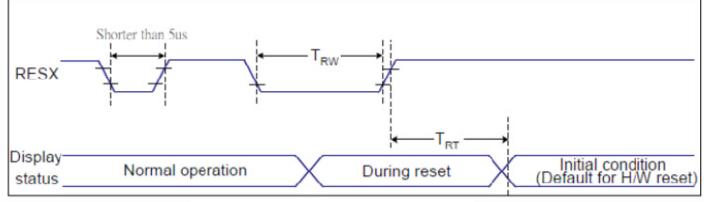


Figure 6.3: Reset Timing Diagram

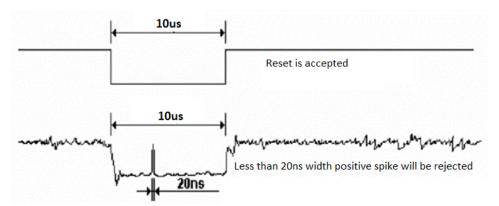
Related Pins	Symbol	Parameter	Min	Max	Unit
	TRW	Reset pulse duration	10	-	us
RESX	TOT	Decet equal	-	5 (Note 1,5)	ms
	TRT	Reset cancel		120 (Note 1, 6, 7)	ms

Notes:

- 1. The reset cancel includes also required time for loading ID bytes, VCOM setting and other settings from NVM (or similar device) to registers. This loading is done every time when there is HW reset cancel time (tRT) within 5ms after a rising edge of RESX.
- 2. Spike due to an electrostatic discharge on RESX line does not because irregular system reset according to the table below:

RESX Pulse	Action
Shorter than 5us	Reset Rejected
Longer than 9us	Reset
Between 5us and 9 us	Reset starts

- 3. During the resetting period, the display will be blanked (the display is entering blanking sequence, which maximum time is 120ms, when reset starts in Sleep Out mode. The display remains the blank state in Sleep in mode) and then return to Default condition for Hardware Reset.
- 4. Spike Rejection also applies during a valid reset pulse as shown below:



- 5. When Reset applied during Sleep In Mode.
- 6. When Reset applied during Sleep Out Mode.
- 7. It is necessary to wait 5ms after releasing RESX before sending commands. Also Sleep Out command cannot be sent for 120ms.



7. Cautions and Handling Precautions

7.1 Handling and Operating the Module

- 1. When the module is assembled, it should be attached to the system firmly. Do not warp or twist the module during assembly work.
- 2. Protect the module from physical shock or any force. In addition to damage, this may cause improper operation or damage to the module and back-light unit.
- 3. Note that polarizer is very fragile and could be easily damaged. Do not press or scratch the surface.
- 4. Do not allow drops of water or chemicals to remain on the display surface. If you have the droplets for a long time, staining and discoloration may occur.
- 5. If the surface of the polarizer is dirty, clean it using some absorbent cotton or soft cloth.
- 6. The desirable cleaners are water, IPA (Isopropyl Alcohol) or Hexane. Do not use ketene type materials (ex. Acetone), Ethyl alcohol, Toluene, Ethyl acid or Methyl chloride. It might permanent damage to the polarizer due to chemical reaction.
- 7. If the liquid crystal material leaks from the panel, it should be kept away from the eyes or mouth. In case of contact with hands, legs, or clothes, it must be washed away thoroughly with soap.
- 8. Protect the module from static; it may cause damage to the CMOS ICs.
- 9. Use fingerstalls with soft gloves in order to keep display clean during the incoming inspection and assembly process.
- 10. Do not disassemble the module.
- 11. Protection film for polarizer on the module shall be slowly peeled off just before use so that the electrostatic charge can be minimized.
- 12. Pins of I/F connector shall not be touched directly with bare hands.
- 13. Do not connect, disconnect the module in the "Power ON" condition.
- 14. Power supply should always be turned on/off by the item Power On Sequence & Power Off Sequence

7.2 Storage and Transportation.

- 1. Do not leave the panel in high temperature, and high humidity for a long time. It is highly recommended to store the module with temperature from 0 to 35 °C and relative humidity of less than 70%
- 2. Do not store the TFT-LCD module in direct sunlight.
- 3. The module shall be stored in a dark place. When storing the modules for a long time, be sure to adopt effective measures for protecting the modules from strong ultraviolet radiation, sunlight, or fluorescent light.
- 4. It is recommended that the modules should be stored under a condition where no condensation is allowed. Formation of dewdrops may cause an abnormal operation or a failure of the module. In particular, the greatest possible care should be taken to prevent any module from being operated where condensation has occurred inside.
- 5. This panel has its circuitry FPC on the bottom side and should be handled carefully in order not to be stressed.